

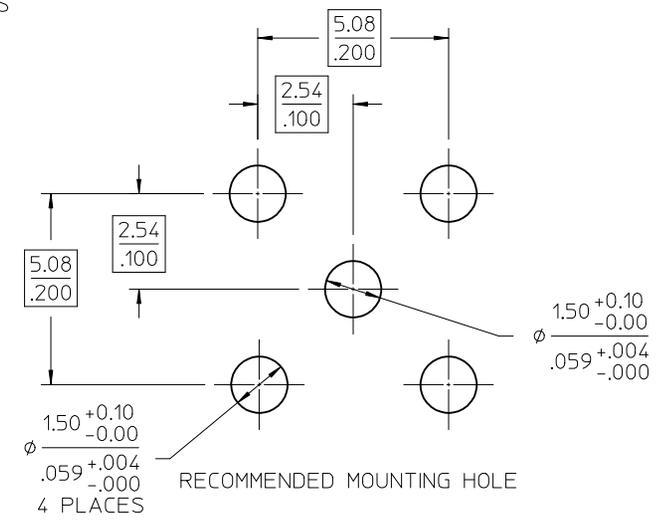
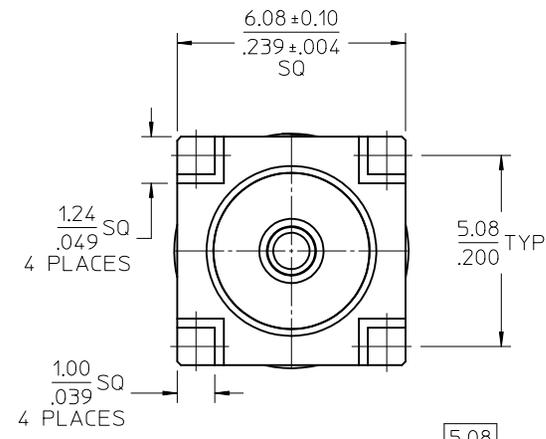
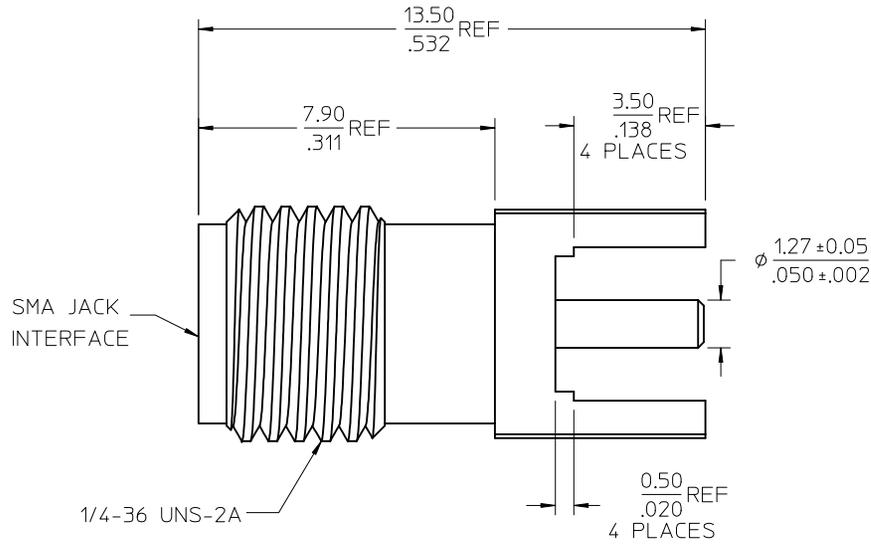
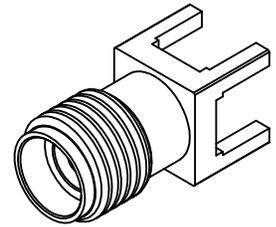
MATERIALS AND FINISHES

BODY: BRASS
PLATED GOLD

CENTER CONTACT: BERYLLIUM COPPER
PLATED GOLD

INSULATOR: TEFLON

PACKAGING: SEE TABLE



PS-89675-346	ELECTRO/MECH. PERFORM.
SPECIFICATION	DESCRIPTION

73391-0072	73391-0070 BY TRAY (20 CAV.)
73391-0071	ONE PIECE 73391-0070 PER BAG
73391-0070	TRAY (80 CAV.)
PART NO.	PACKAGING

CHG: PS WAS 73436-009 EC NO: URF2012-0069 DRWN: WIENER 2011/08/04 CHKD: SSS 2011/08/04 APPR: WIENER 2011/08/10 REV: B4	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± --- ± --- 1 PLACE ± --- ± --- ANGULAR ± 2 °	DIMENSION STYLE MM/IN DRAWN BY DATE LYNN 1998/10/19 CHECKED BY DATE XXX 0000/00/00 APPROVED BY DATE XXX 0000/00/00	SCALE DESIGN UNITS METRIC THIRD ANGLE PROJECTION	TITLE SMA JACK VERTICAL PCB 50 OHMS SMA-J/PCB	MATERIAL NO. SEE TABLE	DOCUMENT NO. SD-73391-007	SHEET NO. 1 OF 1
	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		MOLEX MOLEX INCORPORATED		MOLEX MOLEX INCORPORATED	